

Fully Automatic Double-Sided Soldermask Exposure





Optimized Footprint





Dual Screen HMI

Upper Rocking Frame

Resolution



Min. Dam 50µm | 2 mil



Registration

±8µm | ±0.32mil

Image to Panel





High Savings



Up to 4 panels/min





-85% Cost of **Ownership**



Process Issues





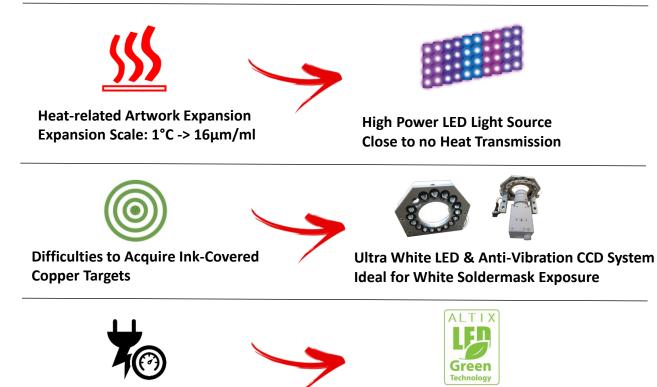
High Energy Requirement for Exposure above 1000mJ +

High Electricity Consumption

Altix Solutions



High Power LED Light Source 4 Wavelengths Ideal for Green, White & Color Soldermask Inks



Low Energy Consumption 4-6 Times Lower than non-LED Sources

Application	Green, White, Black, Orange etc. Inks Soldermask (PSR)
Exposure Area	Up to 610 x 762mm Up to 24 x 30"
Panel Thickness	0.05 - 6mm 0.002 - 0.236"
Resolution	Min. Dam 50μm Min. Dam 2mil
Light Engine	OmniLight™
Light Intensity	≥ 150mW/cm²
Exposure Spectrum	Up to 4 LED Wavelengths 365 to 435nm
Exposure Contact	Soft or Hard Contact Vacuum CMI™ Available
Throughput**	Up to 4 panels/min
Alignment (After Vacuum)	±8μm ±0.32mil Image to Panel
ΔΙΤΙΧ	

ALIIX Manufacturing, Sales & Service: Altix France – Headquarters Email: central@altix.fr Email: kawa@kawa-gmbh.com



Leiterplattentechnik / Industrievertretung

Imaging with us! www.altix.fr

www.kawa-gmbh.com